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USB C type series connectors Product Specification

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Approved/Date	Checked/Date	Written/Date
2024/01/05	2024/01/05	2024/01/05

1.0 Scope : This specification covers the requirements for product performance and test methods of USB C TYPE Series Connectors of the part numbers specified as bellow.

Product shall be of the design, construction and physical dimensions specified in the applicable product drawing.

2.0 Rating:

2.1 Current Rating: VBUS pins(A4,B4,A9 and B9)&GND pins(A1,B1,B12 and A12) 5.0A(1.25A /Pin)

Other pins 0.25A/Pin

2.2 Temperature Range: storage : -20 $^{\circ}$ C to +60 $^{\circ}$ C ;

operatin g:-30 $^{\circ}$ C to +80 $^{\circ}$ C:

Humidity: 90% Rh max.

3.0 Test Condition:

All tests shall be performed as bellow conditions unless otherwise specified.

3.2 Humidity range: 90% Rh max

4.0 Test Methods and Requirements:

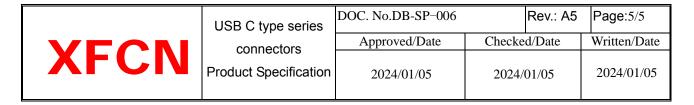
4.1 Examination of product:

Item	Test Description	Test Methods	Requirement
4.1.1 E	xamination of	EIA 364-18	1).Outward appearance shall be
	product (Outward	Shall be confirmed with eyes in	good without such injurious problem
	Appearance	accordance with each drawing.	2).Structure shall be meet the design
	Structure)	Shall be confirmed by using proper	and dimensional requirements of
		measuring instruments.	drawing.
4.2	Electrical Performan	ce:	
Item	Test Description	Test Methods	Requirement
4.2.1	Low Level Contact	EIA 364-23 (or MIL-STD-1344A,	
	Resistance	Method 3002.1, Test Condition B)	
		30m Ω (Max) when measured at	
		20mv(max) open circuit at	40 m Ω Maxi mum
		100mA.Contact resistance below 40 m	
		Ω after 10000 insertion/extraction	
		cycles at a maximum rate of 500 cycles	
		per hour	

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4.2.2 lr	sulatio n Resistance	EIA 364-21					Date Written/Date 05 2024/01/05 m o shortcircuiting and dat AC 100 V R.M.S uirement 5~2.0kgf or insulation orce:					
		(or MIL-STD-202F, Met	hod 302, Test									
		Condition B)		100	$M\Omega$ Mini	mum						
		/D.C 500 V is applied	between									
		adjacent congacts and	insulation									
		resistance is measured	within 1 minute.									
4.2.3 D	iele ctric	EIA 364-20		Ther	e shall be	no shortc	ircuiting and					
	Withstanding Voltage	(or MIL-STD-202F, Met	hod 301, Test	dama	age detec	ted at AC	100 V R.M.S					
		Condition B)		for 1	minute.							
		Test between adjacen										
		mated and unmated co	nnector									
		assemblies.										
		The object of this test	•									
		detail a test method to										
		MICRO USB connector	•									
		safely at its rated voltag										
		momentary over potent										
		switching, surges and/o	or other similar									
		phenomena.										
	echanical Performan	, ,	- d-	1		\	1					
Item	Test Description	Test Meth	oas		F	equireme	nt					
4.3.11	nse rtion Force	EIA 364-13				0.5.000	£.					
		The insertion force test				0.5~∠.0kg	Ī					
4 2 2 1	Tutraction Force	a maximum rate of	12.5000000									
4.3.21	Extraction Force	EIA 364-13 The extraction force te	est aball be done			0 0 - 2 0ka	£ .					
		at a maximum rate o				0.6~2.0kg	I					
4 2 2 D	urability	EIA 364-09	1 12.511111/111111.	1) N	lo floobo	or or incu	lation					
4.3.3 D	urability	Mate and unmate Cor	nector	No flashover or insulation breakdown								
		assemblies for 10000 c		2) Extraction Force:								
		maximum rated of 500					Okaf					
		Flip Interval: Every 25	•	1-1000cycles: 0.8~2.0kgf 1000~10000cycles: 0.6~2.0kgf								
		I lip intorval. Every 20	oo oyoloo			•	1ax.50m Ω					
4.3.4	Mechanical Shock	EIA-364-27B					crosecond or					
7.5.4	inicenamear Shock	Subject mated connect	or to 50G's		duration. S		AUSCOHU UI					
		half-sine shock pulses		long	aurautti. S	oce note						
		duration. Three shocks										
		applied along three mu										
		perpendicular planed for										
		Parparaiodiai pidriod id										

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		shocks								
4.3.5	Vibration	EIA-364-28		No dis	continuit	ies of 1 mic	rosecond or			
		Subject mated connect	ors to	long dı	uration. S	See note				
		10~55~10Hz traversed	in 1 minute at							
		1.52mm amplitude 2 ho	ours each of 3							
		mutually perpendicular	planes.							
4.4 Er	nvironmental Perform	nance:								
Item	Test Description	Test M	lethods			Require	ment			
4.4.1 T	hermal Shock	EIA 364-32, Test Cond	dition I,		1).Shall meet visual					
		(or MIL-202F, Method	107G Condition A	٨.)	requirement, show no physical					
		Subject mated connec	ctors to ten cycles		damage.					
		between –30°C to +80	℃.		2).Shall meet requirements of					
		The object of this test	is to determine th	additional tests as specified in						
		resistance of a micro u	test sequence in Section 5							
		exposure at extremes								
		temperatures and to th	e shock of alterna	ite						
		exposures to these ext	remes, simulating	the						
		wrost case conditions f	or storage,							
		transportation and app								
4.4.2 H	umi dity	EIA 364-31, Test Cond	dition A Method I	of alternate mulating the e, flethod III, 1).Shall meet visual						
		(or MIL-202F, Method 1	103B Test Condition	on B.)	require	ment, show	v no physical			
		Subject mated connec	ctors to 168 Hours	3	damage.					
		(seven complete cycles	3)		2).Shall meet requirements of					
		The object of this test	procedure is to de	etail a	additional tests as specified in					
		standard method for th			test sequence in Section 5					
		properties of materials								
		connectors as these in	fluenced by the ef							
		of high humidity and he								
4.4.3 S	alt Spray	MIL-STD-202F, Metho	1).Shall meet visual							
		Condition B			requirement, show no physical					
		Subject mated connec		at 35	damage.					
		°C with 5%-Salt-solution	on concentration.		,	-	uirements of			
							s specified in			
					test sec	quence in S	Section 5			

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4.4.4 T	emperature Life	EIA 364-17 Test Cond	ition 3 Method A	,	1).Shall	l meet visu	al			
		Subject mated connect at 80°ℂ for 250hours	ctors to temperatu	re life	damage	Э.	v no physical			
					additional tests as specified in					
						quence in S	·			
4.4 En	vironmental Performa	nce: (Continued)								
Item	Test Description	Test Meth	ods		R	Requiremen	nt			
4.4.5 S	olderability	EIA 364-52		The s	urface of	f the portio	n to be			
		After one hour steam	aging.	solder	ed shall	at least 95	5% covered			
		The object of test prod	cedure is to detail	with n	ew solde	er coating,	as specified in			
		a unfirm test methods f	or determining	Categ	ory 2.					
		micro usb connectors s	solderability. The							
		test procedure containe	ed here utilizes							
		the solder dip technique	e. It is not							
		intended to test or eval	uate solder cup,							
		solder eyelet, other har	nd-soldered type							
		or SMT type termination								
4.4.6 R	e sistance to	1) for WAVE SOLDE F		1). No	mechar	nical defec	t on housing			
	Soldering Heat	MIL-STD-202F, Method	d 210A, Test	or oth	er parts.					
		Condition B.								
		Pre-heat : 80	0°C, 60 Seconds							
		Temperature : 26	60 ± 5 °C							
		Immersion duration: 10	0 ± 1 sec.							
		2) for REFLOW SOLDE	RING:							
		EIAJ RCX-0101/102								
		Pre-heat : 150(Mir	n)~200(Max) °ℂ,							
		60 ~18								
		Temperature : 26	60 ± 5 °C							
		Immersion duration : 10	0~40 sec.							
		2-4C*/s TEMP Pre-heat:180-200°c (120sec Min) 2-4C*/sec TIM	C 220°C (60sec Min)							



Test Group (a)			Sample Groups												
Test Item	Test Description		Α		В		С	D)	Е		FG			
4.1.1	Examination of product	1,	13	1,	5	1,	8	1, 3	3	1, 5	1	3	1	6	
4.2.1	Low Level Contact Resistance	2,	10	2,	4					2, 4			2	5	
4.2.2 Insul	atio n Resistance	3	11			2	,6								
4.2.3	Dielectric Withstanding Voltage	4	12			3	,7								
4.3.1	Insertion Force	5	8												
4.3 2	Extraction Force	6	9												
4.3 3	Durability	7													
4.3.4	Mechanical Shock												3		
4.3.5	Vibration										4	4			
4.4.1	Thermal Shock					5									
4.4.2	Humidity					4									
4.4.3	Salt Spray			3											
4.4.4	Temperature Life(see note c)									3					
4.4.5	Solderability					2									
4.4.6	Resistance to Soldering Heat										2				
Num	nber of Test Samples (Minimum)		5		5		5 5			5		5 5			